Copper Skin™ on Al Foil

Conductive Aluminum foil-based films







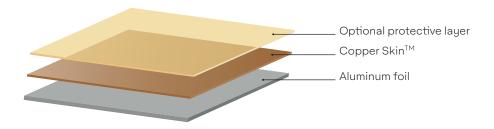
The Problem

Conductive back sheets based on Copper foil are a growing trend in the photovoltaics industry, but cost constraints are driving the search for foil alternatives. Aluminum foil would be the natural choice, with its high conductivity and attractive price. However, Al foil cannot be electrically connected by soldering due to its native oxide layer.

Solution: Copper Skin™ on Aluminum Foil

Avery Dennison Hanita offers a highly conductive Aluminum foil laminate, with a proprietary Copper Skin exterior coating, enabling high electrical connectivity. The laminate provides a cost-effective alternative to the Copper foil used in back contact sheets for PV, delivering the economic benefits of Aluminum foil, and the electrical connectivity of pure Copper substrates. Copper Skin is now available with an optional protective layer to enhance corrosion resistance.

Typical structure



Applications

• Conductive back contact sheets for PV modules





Product Data Overview

Parameter	Min Value (50 mic foil)	Max Value (100 mic foil)	Units
Appearance	One side Aluminum, other side Copper		
Pure Copper Thickness Range	150 - 300		nm
Density	2.5 - 2.7		g/cm3
UTS	>160		N/mn ²
Elongation	>2		A(50%)
Resistivity	26.5 × 10 ⁻⁹		Ω*m
Melting point	660		°C
Coefficient of Linear Expansion	28 x 10 ⁻⁹		C ⁻¹
Thermal Conductivity	230		W/m*C
Recommended storage conditions	5 - 40 <50		°C % RH

Features and Benefits

- Low cost alternative Economic alternative to Copper foil products, manufactured using a proprietary, high volume manufacturing process
- Flexibility of product construction Wide selection of conductive layer thicknesses, precisely matching conductivity demands of application
- Excellent mechanical properties High heat stability, flexibility, metal adhesion and overall durability
- Ready for mass production Available in a range of widths and lengths as required
- · Optional clear protective coating
- Compatible to all soldering processes Reflow, SMT, conductive adhesives, etc.

Please review the storage conditions outlined in the product specification sheets

About Avery Dennison

Avery Dennison Corporation (NYSE: AVY) is a global materials science company specializing in the design and manufacture of a wide variety of labeling and functional materials. The company's products, which are used in nearly every major industry, include pressure-sensitive materials for labels and graphic applications: tapes and other bonding solutions for industrial, medical, and retail applications: tags, labels and embellishments for apparel: and radio frequency identification (RFID) solutions serving retail apparel and other markets. Headquartered in Glendale, California, the company employed more than 32,000 employees in more than 50 countries in 2020. Reported sales in 2020 were \$7.0 billion. Learn more at www.averydennison.com.

For further information contact barrier.laminates@eu.averydennison.com

DISCLAIMER: All Avery Dennison statements, technical information and recommendations are based on tests believed to be reliable but do not constitute a guarantee or warranty. All Avery Dennison products are sold with the understanding that purchaser has independently determined the suitability of such products for its purposes. All Avery Dennison's products are sold subject to Avery Dennison's general terms and conditions of sale, see: terms.europe.averydennison.com

©2022 Avery Dennison Corporation. All rights reserved. Avery Dennison and all other Avery Dennison brands, this publication, its content, product names and codes are owned by Avery Dennison Corporation and/or its Affiliates. All other brands and product names are trademarks of their respective owners. This publication must not be used, copied or reproduced in whole or in part for any purposes other than marketing by Avery Dennison.



